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SUPERMICE

SuperServer 1029TP-DTR





Integrated Board Super X11DPT-PS

Views: | Angled View | Top View | Front View Rear View

<u>Drivers & Utilities</u> <u>BIOS</u> <u>IPMI</u> <u>Tested Memory</u> <u>Tested M.2 List</u> <u>Manuals</u> <u>OS Certification Matrix</u> <u>Quick-References Guide</u> <u>Drive Options</u> <u>Tested SIOM</u> <u>Network Card (AOC) Matrix</u>

- Mission-critical applications

- High Availability Storage **Appliance Platform**

Key Applications / Features

Two hot-pluggable systems (nodes) in a 1U form factor. Each node supports the following:

- 1. Dual Socket P (LGA 3647) support 2nd Gen Intel® Xeon® Scalable processors (Cascade Lake/Skylake)[‡]
- 2. 16 DIMMs; up to 4TB 3DS ECC DDR4-2933MHz[†] RDIMM/LRDIMM
- 3. 2 PCI-E 3.0 x16 slots 4. Flexible Networking support via SIOM;
- 5. 4 Hot-swap 2.5" SATA3 drive bays
- 6. 2 SuperDOM onboard or optional 2 M.2 carrier

Dedicated IPMI 2.0 LAN

Titanium Level (96%)

7. Up to 1000W Redundant Power Supplies



Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

Specifications ^

	Specific Control of the Control of t		
Product SKUs			
SYS-1029TP-DTR	SuperServer 1029TP-DTR (Black)		
Motherboard (Two per Syste	m)		
Super X11DPT-PS			
Processor (per Node)			
CPU	Dual Socket P (LGA 3647) 2nd Gen Intel® Xeon® Scalable Processors and Intel® Xeon® Scalable Processors‡, Dual UPI up to 10.4GT/s Support CPU TDP 70-145W (Consult with SYS PM for higher CPU TDP Supports)		
Cores	Up to 28 Cores		
Note	*Processors ending N or S are optimized for networking and storage applications. Customer need POC their application and observe any thermal throttling before large deployment.		
Note	[‡] BIOS version 3.2 or above is required to support 2nd Gen Intel® Xeon® Scalable processors (codenamed Cascade Lake-R)		
System Memory (per Node)			
Memory Capacity	16 DIMM slots Up to 4TB 3DS ECC DDR4-2933MHz [†] RDIMM/LRDIMM		

	memory purchased from Supermicro
On-Board Devices (per Node)	

Memory Type

Note

Intel® C621 chipset Chipset SATA3 (6Gbps); RAID 0, 1, 5, 10 **SATA** Barebones and Complete System must have at least one **Network Controllers**

SIOM card installed per node Support for Intelligent Platform Management Interface v.2.0 **IPMI** IPMI 2.0 with virtual media over LAN and KVM-over-LAN support

Graphics ASPEED AST2500 BMC Input / Output (per Node)

SATA

Serial Port / Header

BIOS Type

1 RJ45 Dedicated IPMI LAN port LAN **USB** 2 USB 3.0 ports (rear) 1 VGA port **VGA**

AMI 32MB SPI Flash ROM

Intel[®] Node Manager

4 SATA3 (6Gbps) ports

2 <u>SuperDOM</u> support on the motherboard Others 1 NVMe or 2 SATA M.2 (22x80/60/42 mm) support with option part: AOC-SMG3-2H8M2

M.2 and SuperDOM are for OS boot and they cannot coexist

1 Fast UART 16550 port / 1 Header (internal)

2933[†]/2666/2400/2133MHz ECC DDR4 RDIMM/LRDIMM

[†] 2933MHz in two DIMMs per channel can be achieved by using

System BIOS

Management

Software

<u>IPMI 2.0</u> KVM with dedicated LAN NMI SSM, SPM, SUM SuperDoctor® 5

Watchdog

Power Configurations ACPI Power Management PC Health Monitoring

CPU

Parts List - (Items Included)

4+1 Phase-switching voltage regulator Fans with tachometer monitoring **FAN** Status monitor for speed control

Monitors for CPU Cores, Chipset Voltages, Memory.

Pulse Width Modulated (PWM) fan connectors Monitoring for CPU and chassis environment **Temperature**

Thermal Control for fan connectors

Chassis

Form Factor	1U Rackmount
Model	CSE-809H-R1K05P3
nensions and Weight	

Width 17.2" (437mm) 1.7" (88mm) Height 28.25" (718mm) Depth 29.6" (W) x 8" (H) x 38.4" (L) **Package** Gross Weight: 48.1 lbs (21.9 kg) Weight Net Weight: 33.5 lbs (15.2 kg)

Front Panel

Power On/Off button **Buttons UID** button Power status LED **LEDs HDD** activity LED Network activity LEDs Universal Information (UID) LED

Expansion Slots (per Node)

2 PCI-E 3.0 x16 Low-profile slots **PCI-Express** 1 SIOM card support

Note: Barebones and Complete System must bundle with **SIOM**

(With only one CPU installed, SXB2 M.2 and SXB4 riser card slots not function)

4 Hot-swap 2.5" SAS3/SATA3 drive bays

Drive Bays (per Node)

Hot-swap

SAS3 backplane

System Cooling

Backplane

3 Heavy duty counter rotating fans with air shroud and optimal fan speed control **PowerStick Power Supply**

1000W 1U Redundant Power Supplies with PMBus

Total Output Power 800W: 100 – 127Vac 1000W: 200 - 240Vac

Fans

Dimension 38 x 40 x 360 mm $(W \times H \times L)$ 100-127Vac / 9-7.5A / 50-60Hz Input 200-240Vac / 6-5A / 50-60Hz Max: 66.7A / Min: 0A (100-127Vac) +12V

> Max: 83A / Min: 0A (200-240Vac) Max: 4A / Min: 0A +5Vsb Gold Finger Connector (16 Power Pin, 14 Signal Pin) **Output Type**

Titanium Level [Test Report]

Operating Environment RoHS

RoHS Compliant Operating Temperature: **Environmental Spec.** 10°C ~ 35°C (50°F ~ 95°F)

Certification

Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) Operating Relative Humidity: 8% to 90% (non-condensing) Non-operating Relative Humidity: 5% to 95% (non-condensing)

Parts List ^

	Part Number	Qty	Description
Motherboard / Chassis	MBD-X11DPT-PS CSE-809H-R1K05P3	2 1	Super X11DPT-PS Motherboards 1U Chassis
Backplane	BPN-ADP-6SATA3P	2	Backplan adapter card; 6SATA ports,RoHS/REACH,PBF
Backplane	BPN-SAS3-809H	1	8-port 1U TwinPro SAS3 12Gbps (4 drives per node) backplane, support up to 8x 2.5-inch SAS3/SATA3 HDD/SSD
Cable 1	CBL-PWCD-0900	2	PWCD,US/EU/Canada/China/Australia,IEC60320 C14 TO C13,4FT,17AWG
Manual	MNL-2112-QRG	1	1029TP-DTR/DC0R/DC1R Quick Reference Guide
Riser Card	RSC-P-6	2	RSC-P-6 (1U LHS TwinPro RSC with 1 PCI-Ex16),RoHS
Riser Card	RSC-R1UTP-E16R	2	1U RHS TwinPro Riser card with one PCI-E x16 slot
Heatsink / Retention	SNK-P0067PS	2	1U Passive CPU Heat Sink for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Heatsink / Retention	SNK-P0067PSM	2	1U Passive CPU Heat Sink with a 26-mm Wide Middle Air Channel for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Power Supply	PWS-1K05A-1R	2	1U 1000W Redundant Power Supply Titanium, 38X40X360mm length
Optional Parts List			

	Part Number	Qty	Description
TPM security module (optional, not included)	AOM-TPM-9670V	1	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor
TPM security module (optional, not included)	AOM-TPM-9671V	1	SPI capable TPM 1.2 with Infineon 9670 controller with vertical form factor
Carrier Card	AOC-SMG3-2H8M2	-	AOC supports 2280 M.2 form factor SSD (1 NVMe or 2 SATA), FST-SCRW-0121L is included in AOC-SMG3-2H8M2
Global Services & Support	OS4HR3/2/1 OSNBD3/2/1		3/2/1-year onsite 24x7x4 service 3/2/1-year onsite NBD service
Software	SFT-OOB-LIC • eStore	1	OOB Management Package (per node license)
Software	SFT-DCMS-Single	1	DataCenter Management Package (per node license)

Global SKU English





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